

DATASHEET

SMD • REFLECTOR 67-21/GBC-YV2W2N/2T



Features

- . P-LCC-2 package.
- . White package.
- . Optical indicator.
- . Colorless clear window.
- . Wide viewing angle.
- . Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- . Computable with automatic placement equipment.
- . Available on tape and reel (8mm Tape).
- . Pb-free
- The product itself will remain within RoHS compliant version

Descriptions

. The 67-21 series is available in soft orange, green, blue and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes TOP LED ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application where power is at a premium.

Applications

- . Automotive: backlighting in dashboard and switch.
- . Telecommunication: indicator and backlighting in telephone and fax.
- . Flat backlight for LCD, switch and symbol.
- . Light pipe application.
- . General use.



Device Selection Guide

Chip Materials	Emitted Color	Resin Color
InGaN/SiC	Brilliant Green	Water Clear

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	l _F	30	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	100	mA	
Power Dissipation	Pd	110	mW	
Electrostatic Discharge (HBM)	ESD	1000	V	
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\mathbb{C}$	
Soldering Temperature	T_{sol}	Reflow Soldering : 260 $^{\circ}\mathbb{C}$ for 30 sec. Hand Soldering : 350 $^{\circ}\mathbb{C}$ for 3 sec.		

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	900		1800	mcd	I _F =20mA
Viewing Angle	$2\theta_{1/2}$		120		deg	I _F =20mA
Peak Wavelength	λр		518		nm	I _F =20mA
Dominant Wavelength	λd	520		535	nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ		35		nm	I _F =20mA
Forward Voltage	V_{F}	2.7		3.7	V	I _F =20mA
Reverse Current	I _R			50	μA	V _R =5V

Note:

- 1. Tolerance of Luminous Intensity: ±11%
- 2. Tolerance of Dominant Wavelength: ±1nm
- 3. Tolerance of Forward Voltage: ±0.1V



Bin Range of Luminous Intensity

Bin Code	Min.	Max.	Unit	Condition
V2	900	1120		
W1	1120	1420	mcd	$I_F = 20 \text{mA}$
W2	1420	1800		·

Note:

Tolerance of Luminous Intensity: ±11%

Bin Range of Dominant Wavelength

Bin Code	Min.	Max.	Unit	Condition
X	520	525		
Υ	525	530	_ nm	$I_F = 20 \text{mA}$
Z	530	535	_	·

Note:

Tolerance of Dominant Wavelength: ±1nm

Bin Range of Forward Voltage

Bin Code	Min.	Max.	Unit	Condition
10	2.70	2.90		
11	2.90	3.10		
12	3.10	3.30	V	IF=20mA
13	3.30	3.50		
14	3.50	3.70		

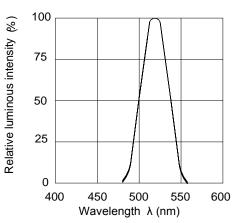
Note:

Tolerance of Forward Voltage: ±0.1V

Ta=25°C

Typical Electro-Optical Characteristics





Forward Voltage(V)-volts

Forward Current I_F (mA)

40

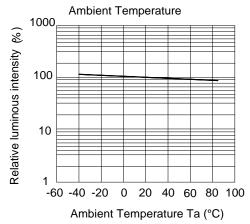
30

20

10

0

Relative Luminous Intensity vs.



Relative Luminous Intensity vs

3.6

3.8

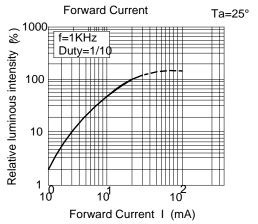
4.0

3.2

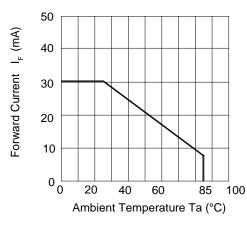
3.0

Forward Current vs.

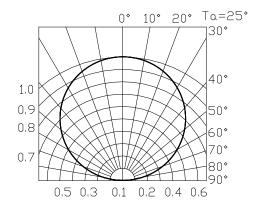
Forward Voltage



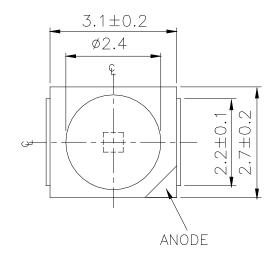
Forward Current Derating Curve

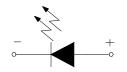


Radiation Diagram

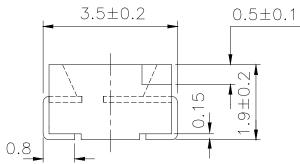


Package Dimensions



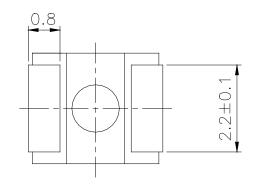


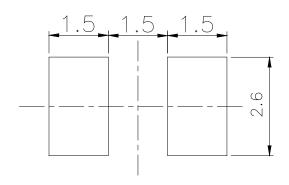
Polarity





For reflow soldering (Proposal)







Moisture Resistant Packing Materials

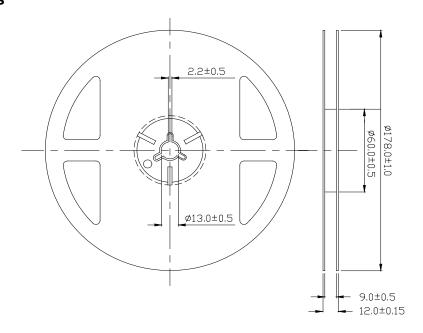
CAT: Luminous Intensity Rank HUE: Dom. Wavelength Rank REF: Forward Voltage Rank

Label Explanation

CAT: Luminous Intensity Rank HUE: Dom. Wavelength Rank REF: Forward Voltage Rank

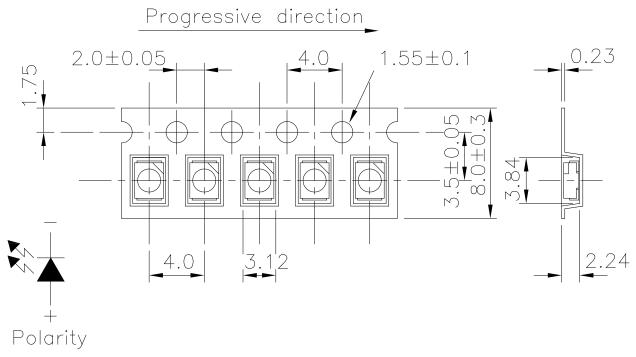


Reel Dimensions



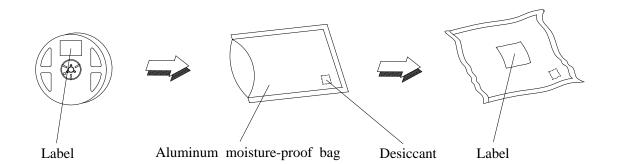
Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel.



Note: The tolerances unless mentioned is ± 0.1 mm; Unit = mm

Moisture Resistant Packaging





Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp.: 260 °C±5 °C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	H: +100°C 15min ∫ 5 min L: -40°C 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100 ℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	IF = 20 mA	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85 ℃/85%RH	1000 Hrs.	22 PCS.	0/1

Precautions for Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

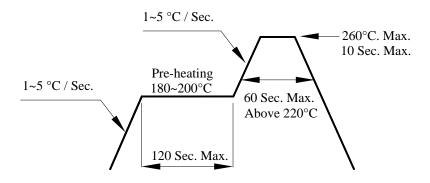
2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life are 168 hours under 30℃ or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours.

3. Soldering Condition

3.1 Pb-free solder temperature profile





- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

